

Ultrafast Diode 60 A, 400 V

FFH60UP40S, FFH60UP40S3

Description

The FFH60UP40S, FFH60UP40S3 is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application as welder and UPS application.

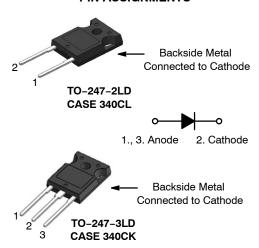
Features

- Ultrafast Recovery, $T_{rr} = 85 \text{ ns } (@ I_F = 60 \text{ A})$
- Max Forward Voltage, $V_F = 1.3 \text{ V}$ (@ $T_C = 25^{\circ}\text{C}$)
- Avalanche Energy Rated
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

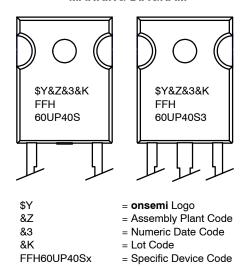
Applications

- General Purpose
- SMPS, Welder, UPS
- Free-wheeling Diode for Motor Application
- Power Switching Circuits

PIN ASSIGNMENTS



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

1

FFH60UP40S, FFH60UP40S3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

| Symbol | Parameter | Value | Unit |
|-----------------------------------|--|-------------|------|
| V_{RRM} | Peak Repetitive Reverse Voltage | 400 | V |
| V_{RWM} | Working Peak Reverse Voltage | 400 | V |
| V_{R} | DC Blocking Voltage | 400 | V |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 139°C | 60 | Α |
| I _{FSM} | Non-repetitive Peak Surge Current 60 Hz Single Half-Sine Wave | 600 | Α |
| T _J , T _{STG} | Operating and Storage Temperature Range | -65 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Symbol | Parameter | Value | Unit |
|----------------|--|-------|------|
| $R_{	heta JC}$ | Maximum Thermal Resistance, Junction to Case | 0.2 | °C/W |

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

| Symbol | Parar | neter | Min | Тур | Max | Unit |
|-------------------------|---|------------------------|-----|------|-----|------|
| V _F (Note 1) | I _F = 60 A | T _C = 25°C | - | 1.06 | 1.3 | V |
| | | T _C = 100°C | - | 0.99 | - | |
| I _R (Note 1) | V _R = 400 V | T _C = 25°C | - | - | 100 | μΑ |
| | | T _C = 100°C | - | - | 500 | |
| t _{rr} | $I_F = 60 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A}/\mu\text{s}, \ V_B = 260 \text{ V}$ | T _C = 25°C | - | 59 | 85 | ns |
| | V _R = 200 V | T _C = 100°C | - | 96 | - | |
| W _{AVL} | Avalanche Energy (L = 40 mF | 1) | 50 | _ | - | mJ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

| Part Number | Device Marking | Package | Shipping |
|-------------|----------------|--|------------------|
| FFH60UP40S | FFH60UP40S | TO-247-2LD (Pb-Free / Halogen Free) | 450 Units / Tube |
| FFH60UP40S3 | FFH60UP40S3 | TO-247-3LD (Pb-Free / Halogen Free) | 450 Units / Tube |

^{1.} Pulse: Test Pulse Width = 300 μs, Duty Cycle = 2%

FFH60UP40S, FFH60UP40S3

TEST CIRCUIT AND WAVEFORM

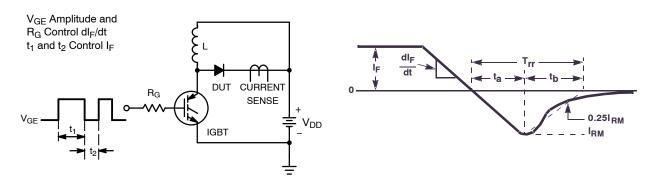


Figure 1. Diode Reverse Recovery Test Circuit and Waveform

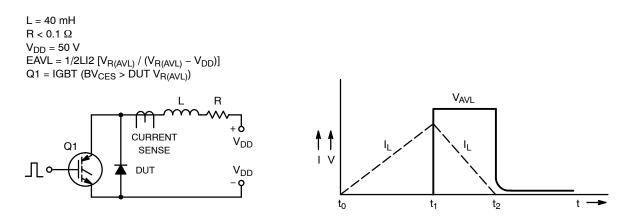


Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

FFH60UP40S, FFH60UP40S3

TYPICAL PERFORMANCE CHARACTERISTICS

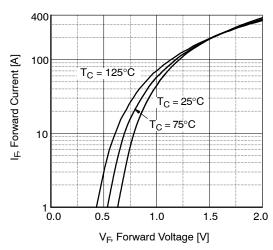


Figure 3. Typical Forward Voltage Drop vs. Forward Current

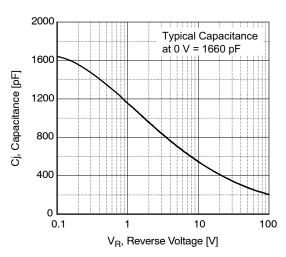


Figure 5. Typical Junction Capacitance

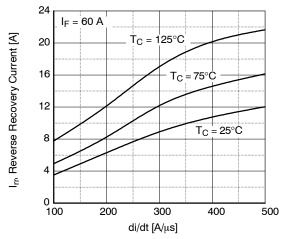


Figure 7. Typical Reverse Recovery Current vs. di/dt

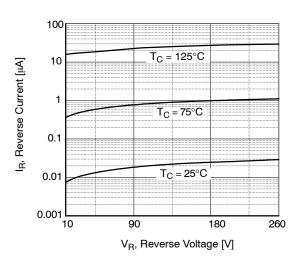


Figure 4. Typical Reverse Current vs. Reverse Voltage

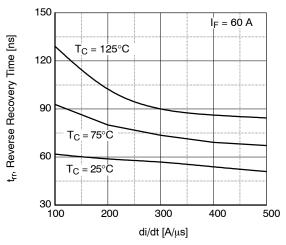


Figure 6. Typical Reverse Recovery Time vs. di/dt

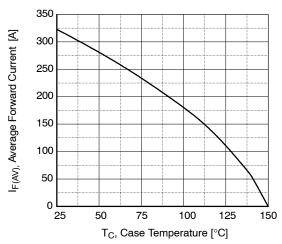
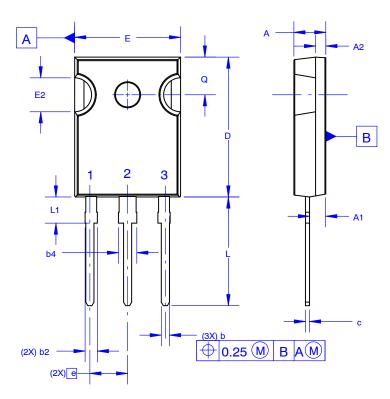


Figure 8. Forward Current Derating Curve

TO-247-3LD SHORT LEAD

CASE 340CK ISSUE A





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

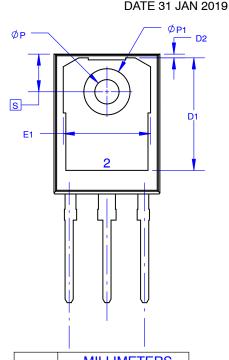
A = Assembly Location

Y = Year

WW = Work Week

ZZ = Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

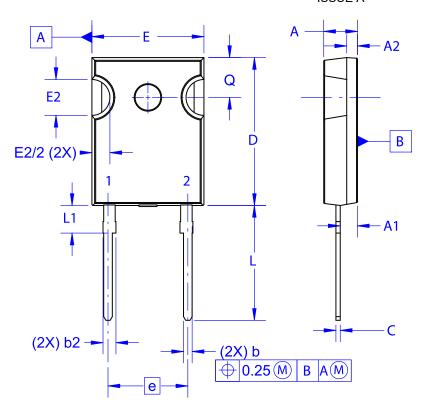


| DIM | MILLIMETERS | | | |
|-------------|-------------|-------|-------|--|
| DIIVI | MIN | NOM | MAX | |
| Α | 4.58 | 4.70 | 4.82 | |
| A1 | 2.20 | 2.40 | 2.60 | |
| A2 | 1.40 | 1.50 | 1.60 | |
| b | 1.17 | 1.26 | 1.35 | |
| b2 | 1.53 | 1.65 | 1.77 | |
| b4 | 2.42 | 2.54 | 2.66 | |
| С | 0.51 | 0.61 | 0.71 | |
| D | 20.32 | 20.57 | 20.82 | |
| D1 | 13.08 | ~ | ~ | |
| D2 | 0.51 | 0.93 | 1.35 | |
| E | 15.37 | 15.62 | 15.87 | |
| E1 | 12.81 | ~ | ~ | |
| E2 | 4.96 | 5.08 | 5.20 | |
| е | ~ | 5.56 | ~ | |
| L | 15.75 | 16.00 | 16.25 | |
| L1 | 3.69 | 3.81 | 3.93 | |
| ØΡ | 3.51 | 3.58 | 3.65 | |
| Ø P1 | 6.60 | 6.80 | 7.00 | |
| Q | 5.34 | 5.46 | 5.58 | |
| S | 5.34 | 5.46 | 5.58 | |

| DOCUMENT NUMBER: | 98AON13851G | Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | |
|------------------|-----------------------|--|-------------|--|
| DESCRIPTION: | TO-247-3LD SHORT LEAD | | PAGE 1 OF 1 | |

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

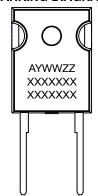
TO-247-2LD CASE 340CL **ISSUE A**





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
 D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

= Assembly Location

= Year

WW = Work Week

= Assembly Lot Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

| | DATE 03 E | |
|-------|-----------|---------|
| Ø P — | | Ø P1 D2 |
| E1 — | 1 | D1 |
| , | | 9 |

| DIM | MILLIMETERS | | |
|--------------|-------------|-------|-------|
| | MIN | NOM | MAX |
| Α | 4.58 | 4.70 | 4.82 |
| A1 | 2.29 | 2.40 | 2.66 |
| A2 | 1.30 | 1.50 | 1.70 |
| b | 1.17 | 1.26 | 1.35 |
| b2 | 1.53 | 1.65 | 1.77 |
| С | 0.51 | 0.61 | 0.71 |
| D | 20.32 | 20.57 | 20.82 |
| D1 | 16.37 | 16.57 | 16.77 |
| D2 | 0.51 | 0.93 | 1.35 |
| Е | 15.37 | 15.62 | 15.87 |
| E1 | 12.81 | ~ | ~ |
| E2 | 4.96 | 5.08 | 5.20 |
| е | ~ | 11.12 | ~ |
| L | 15.75 | 16.00 | 16.25 |
| L1 | 3.69 | 3.81 | 3.93 |
| ØΡ | 3.51 | 3.58 | 3.65 |
| Ø P 1 | 6.61 | 6.73 | 6.85 |
| Q | 5.34 | 5.46 | 5.58 |
| S | 5.34 | 5.46 | 5.58 |

| DOCUMENT NUMBER: | 98AON13850G | Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. | | |
|------------------|-------------|--|-------------|--|
| DESCRIPTION: | TO-247-2LD | | PAGE 1 OF 1 | |

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer pu

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

TECHNICAL SUPPORT North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative